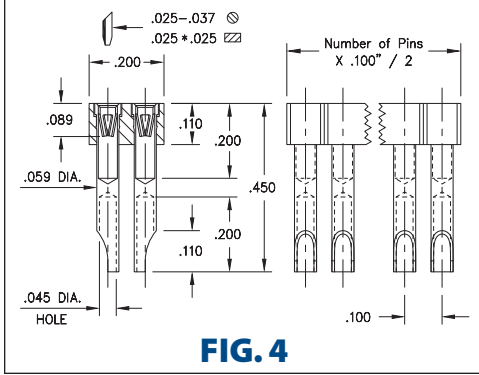
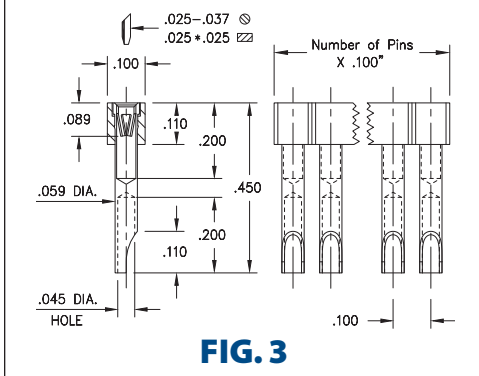
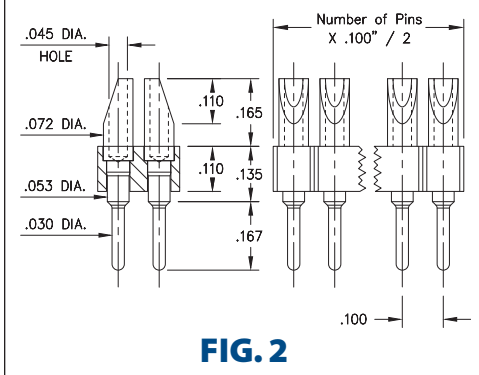
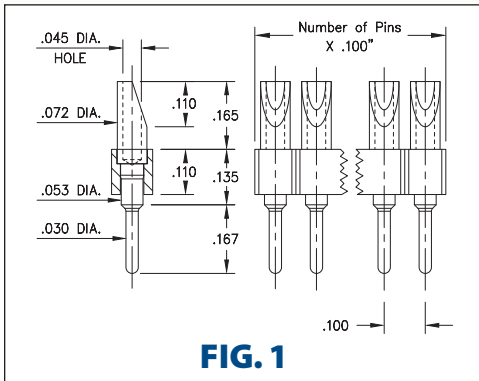
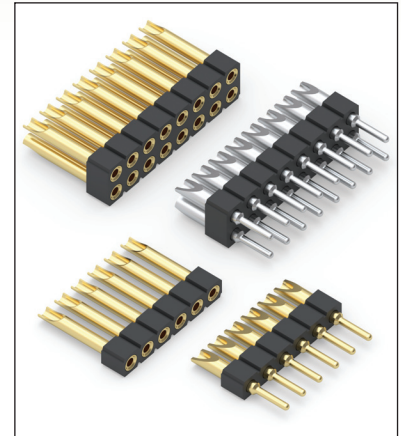


INTERCONNECTS

SERIES 800, 801, 802, 803 • .100" GRID SOLDER CUP HEADERS AND SOCKETS • SINGLE AND DOUBLE ROW STRIPS



- Series 800 and 802 use MM #1107 pins. See page 218 for details
- Series 801 and 803 use MM #1134 pin receptacles and accept pin diameters from .025"-.037" and .025" square pins. See page 177 for details
- Series 801 and 803 receptacles use Hi-Rel, 4-finger BeCu #47 contact rated at 4.5 amps. See page 256 for details
- Solder cups are pre-aligned and accept up to 20 AWG wire
- Insulators are high temperature thermoplastic, suitable for all soldering operations



ORDERING INFORMATION




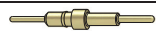








FIG. 1	Series 800...007 Single Row Solder Cup / Solder Tail
	800-XX-0__-10-007000 Specify number of pins ↑ 02-64
FIG. 2	Series 802...007 Double Row Solder Cup / Solder Tail
	802-XX-0__-10-007000 Specify number of pins ↑ 02-64
  	
SPECIFY PLATING CODE XX=	
Pin Plating 	10  10 μ" Au
	40  200 μ" Sn

FIG. 3	Series 801...007 Single Row Solder Cup Sockets
	801-13-0__-10-007000 Specify number of pins ↑ 02-64
FIG. 4	Series 803...007 Double Row Solder Cup Sockets
	803-13-0__-10-007000 Specify number of pins ↑ 02-64
  	
SPECIFY PLATING CODE XX=	
Sleeve (Pin) 	13  10 μ" Au
Contact (Clip) 	30 μ" Au

